

Wireless Module AC75

The application platform becomes robust



Quad-Band, EDGE CLASS 10, Java™ and compliance with all relevant quality standards for the automotive sector make AC75 the best equipped hardware and software platform for wireless applications, which are deployed in tough environments. The integrated technologies guarantee worldwide usability, highest data transfer rates as well as time and cost saving developments.

The module includes the Java™ open platform, with which engineers can use components readily available on the module, such as processor and

memory, for their applications. This advantage plus compliance with the high quality standards for the automotive sector such as ISO TS16949, additional quality enhancements like VDA 1.5 compliant audio quality and extended operative temperature secure your professional application. The AC75 also offers SIM Access Profile and the RIL-Driver for Microsoft® Windows Mobile™ based devices. To guarantee your short time-to-market we offer integration support based on in-depth, long-term experience in the automotive sector.

Worldwide usability, highest quality standards, intelligent and resource-saving development – AC75 is the first rugged module in the world to integrate all these features on one board. Thus it creates a perfect basis for applications which demand extra quality and robustness such as emergency call and toll collect, security, fleet management as well as other machine-to-machine applications.

AC75 offers full type approval including the approval of US mobile operators and e-mark, thus providing all necessary certification.

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Quad-Band
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EDGE Class 10
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GPRS Class 12
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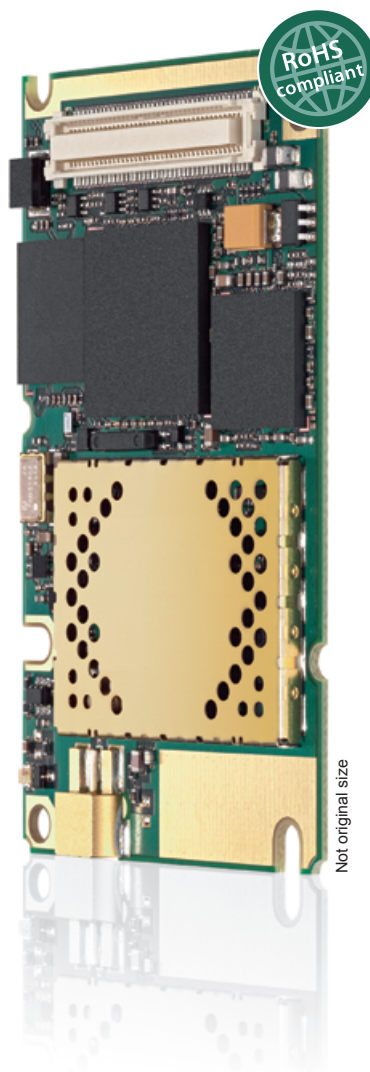
JAVA IMP-NG
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RIL Driver
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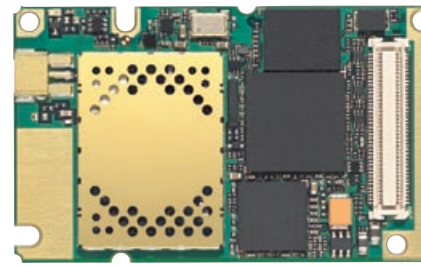
TCP/IP Connectivity
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SIM Access Profile
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Extended Temperature Range



The robust application platform for worldwide wireless automotive solutions



Original size

General features:

- Quad-Band
GSM 850/900/1800/1900 MHz
- EDGE (E-GPRS) multi-slot class 10
- GPRS multi-slot class 12
- GSM release 99
- Output power:
 - Class 4 (2W) for EGSM850
 - Class 4 (2W) for EGSM900
 - Class 1 (1W) for GSM1800
 - Class 1 (1W) for GSM1900
- Control via AT commands (Hayes 3GPP TS 27.007 and 27.005)
- SIM Application Toolkit (release 99)
- TCP/IP stack access via AT commands
- Internet Services: TCP, UDP, HTTP, FTP, SMTP, POP3
- Supply voltage range: 3.3 ... 4.5 V
- Power consumption:
 - Power down 50 µA
 - Sleep mode (registered DRX = 5) 4.6 mA
 - Speech mode (average) 335 mA
 - GPRS class 12 (average) 710 mA
- Charging control for Lithium batteries
- Temperature range
 - Operation: -30°C to +85°C
 - Switch off: +93°C
 - Storage: -40°C to +85°C
- Dimensions: 33.9 x 55 x 3.15 mm
- Weight: approx. 8.5 g

Specification for SMS:

- Point-to-point MO and MT
- SMS cell broadcast
- Text and PDU mode

Specification for voice:

- Triple-rate codec for HR, FR, and EFR
- Adaptive multi-rate AMR
- Enhanced hands-free operation according to VDA Specification for hands-free terminals, Version 1.5

Specification for EDGE data transmission:

- EDGE class 10: max. 236.8 kbps (DL)
- Mobile station class B
- Modulation and coding scheme MCS 1-9

Specification for GPRS data transmission:

- GPRS class 12: max. 86 kbps (DL & UL)
- Mobile station class B
- PBCCH support
- Coding schemes CS 1-4

Specification for CSD data transmission:

- Up to 14.4 kbps
- V.110
- Non-transparent mode
- USSD support

Approvals:

- R&TTE, FCC, UL, IC, GCF, PTCRB, e-mark, CE
- Local approvals and network operator certifications

Java™ features:

- CLDC HotSpot™ Implementation 1.1.2
- Java ME™ profile IMP-NG
- Secure data transmission with HTTPS and PKI

Open application resources:

- ARM® Core, Blackfin® DSP
- Memory: 400 KB (RAM), 1.7 MB (Flash)
- Improved power-saving modes
- On-device-debugging

Specification for fax:

- Group 3, class 1

Interfaces:

- Rosenberger SMP 50 Ω antenna connector (meets automotive requirements)
- 80-pin board-to-board connector
 - Power supply
 - Audio: 2x analog, 1x PCM
 - 2x serial interfaces (ITU-T V.24 protocol)
 - USB 2.0 full speed
 - SIM card interface 3 V, 1.8 V
 - I²C bus and SPI bus
 - Multiple GPIOs, PWM

Special automotive features:

- SIM Access Profile integrated
- Extended temperature range
- Measurement of module temperature
- Antenna diagnostic
- Emergency call even at high temperature
- IMDS listed & GASDL compliant
- ISO/TS16949 development and manufacturing
- RIL software for Microsoft® Windows Mobile™ 5.0 based devices
- Multiplexer driver for Microsoft® Windows

Over-the-air update:

- Application SW: OTAP
- Firmware: FOTA (OMA compliant)

Global thinking,
local understanding.



U.K. ← Football → USA

Here, there and everywhere

Global but local – Cinterion lives up to this motto! Not only are we present locally but we are also able to open up amazing global business perspectives for you! Find the details of your local Cinterion contact partner here: www.cinterion.com

Technical Support

Our application engineers support you from the design-in phase over the integration of the module into the application to the certification process.

We protect your business

Profit from our strong Intellectual Property Rights position (IPR) – guarded by our legal professionalism you secure the fruits of your business effort.

Our technology portfolio covers → +++ Java™ Open Platform +++ EDGE +++ GPS +++ HSDPA +++